

TC518129AP/ASP/AF/AFW-80,-10,-12

TC518129APL/ASPL/AFL/AFWL/AFTL/ATRL-80,-10,-12

131,072 WORDS × 8 BIT CMOS PSEUDO STATIC RAM

DESCRIPTION

The TC518129A Family is a 1M bit high speed CMOS Pseudo Static RAM organized as 131,072 words by 8 bits. The TC518129A Family utilizing one transistor dynamic memory cell with CMOS peripheral circuit provides large capacity, high speed and low power features. The feature includes single power supply of $5V \pm 10\%$. The RFSH input allows two types of refresh operation - auto refresh and self refresh. The TC518129A Family also features static RAM like write function that the input data is written into the memory cell at the rising edge of R/W, thus being easy to interface with microprocessor.

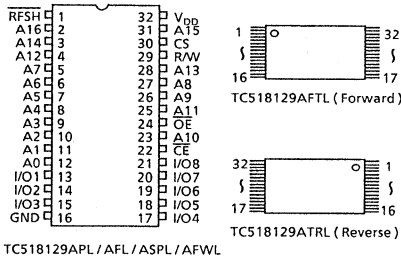
CS standby mode being adopted in the TC518129A Family, CE2 pin in the TC518128A Family is changed to CS pin. This is moulded in a 32 pin standard 0.6 inch and 0.3 inch width plastics DIP and small-out line plastic flat package and a 32 pin plastic thin small - out - line package (forward, reverse type).

FEATURES

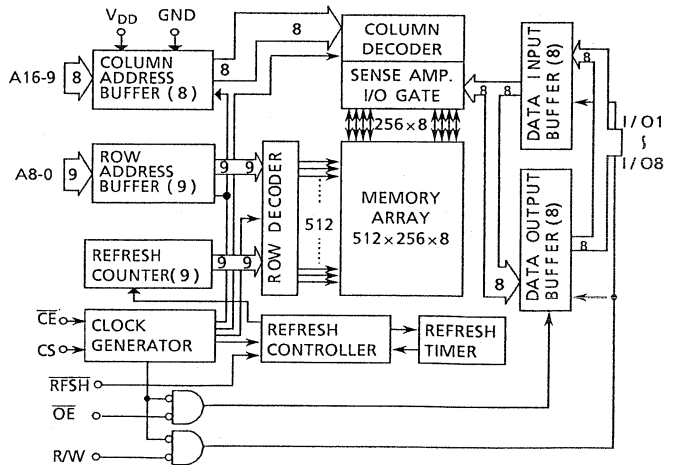
- Organization: 1M bit (131,072 word × 8bit)
- Fast Access Time and Low Power Dissipation
- Single Power Supply : $5V \pm 10\%$
- Auto refresh is capable by internal counter.
- Self refresh is capable by internal timer.
- All inputs and outputs : TTL compatible
- 512 refresh cycle / 8ms
- Auto refresh power down function
- Pin Compatible : 1M SRAM (JEDEC)
- Logic Compatible : SRAM R/W Pin
- Logic Compatible : SRAM R/W Pin
- Package: TC518129AP / APL : DIP32-P-600
 TC518129AF / AFL : SOP32-P-450
 TC518129ASP / ASPL : DIP32-P-300B
 TC518129AFW / AFWL : SOP32-P-525
 TC518129AFTL : TSOP32-P-0820
 TC518129ATRL : TSOP32-P-0820A

	TC518129A Family		
	- 80	- 10	- 12
t _{CEA} CE Access Time	80ns	100ns	120ns
t _{OE} OE Access Time	35ns	40ns	50ns
t _{RC} Cycle Time	130ns	160ns	190ns
Power Dissipation	385mW	330mW	275mW
Self Refresh Current	1mA / 200 μ A (L version)		

PIN CONNECTION (TOP VIEW)



BLOCK DIAGRAM



PIN NAMES

A0~A16	Address Inputs
R/W	Read / Write Control Input
OE	Output Enable Input
RFSH	Refresh Input
CE	Chip Enable Inputs
CS	Chip Select Inputs
I/O1~I/O8	Data Inputs / Outputs
V _{DD}	Power
GND	Ground

(TSOP)

Pin No.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
Pin Name	A ₁₁	A ₉	A ₈	A ₁₃	R/W	CS	A ₁₅	V _{DD}	RFSH	A ₁₆	A ₁₄	A ₁₂	A ₇	A ₆	A ₅	A ₄
Pin No.	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
Pin Name	A ₃	A ₂	A ₁	A ₀	I/O1	I/O2	I/O3	GND	I/O4	I/O5	I/O6	I/O7	I/O8	CE	A ₁₀	OE

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FUNCTION LOGIC

\overline{CE}	CS	\overline{OE}	R/W	RF5H	A0 ~ A16	I/O1 ~ 8	CONDITION
L	H	L	H	*	V*	OUT	Read
L	H	*	L	*	V*	IN	Write
L	H	H	H	*	V*	HZ	\overline{CE} only Refresh
L	L	*	*	*	*	HZ	CS standby
H	*	*	*	L	*	HZ	Auto/Self Refresh
H	*	*	*	H	*	HZ	Stand by

H ... High Level Input ($V_{IN} = 6.5V \sim V_{IH}$ min.)

L ... Low Level Input ($V_{IN} = V_{IL}$ max. $\sim -1.0V$)

* ... Don't care ($6.5V \sim -1.0V$)

V* ... At \overline{CE} falling edge, all address inputs are "IN", and at the other condition, the address input are "*".

HZ ... High Impedance

ABSOLUTE MAXIMUM RATINGS

SYMBOL	ITEM	RATING	UNITS	NOTE
V_{IN}	Input Voltage	-1.0~7.0	V	1
V_{OUT}	Output Voltage	-1.0~7.0	V	
V_{DD}	Power Supply Voltage	-1.0~7.0	V	
T_{OPR}	Operating Temperature	0~70	°C	
T_{STG}	Storage Temperature	-55~150	°C	
T_{SOLDER}	Soldering Temperature · Time	260 · 10	°C · sec	
P_D	Power Dissipation	600	mW	
I_{OUT}	Short Circuit Output Current	50	mA	

D.C. RECOMMENDED OPERATING CONDITIONS ($T_a = 0 \sim 70^\circ C$)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT.	NOTE
V_{DD}	Power Supply Voltage	4.5	5.0	5.5	V	2
V_{IH}	Input High Voltage	2.4	-	6.5	V	
V_{IL}	Input Low Voltage	-1.0	-	0.8	V	

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D.C. ELECTRICAL CHARACTERISTICS ($V_{DD} = 5V \pm 10\%$, $T_a = 0 \sim 70^\circ C$)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNITS	NOTES	
I _{DDO}	Operating Current (Average Power Supply Operating Current) \overline{CE} , Address cycling: $t_{RC} = t_{RC \text{ min}}$.	80ns version	-	50	70	mA	3, 4
		100ns version	-	40	60		
		120ns version	-	35	50		
I _{DD51}	Standby Current $\overline{CE} = V_{IH}$ $\overline{RFSH} = V_{IH}$	Normal version	-	-	2	mA	
		L version	-	-	1		
I _{DD52}	Standby Current $\overline{CE} = V_{DD} - 0.2V$ $\overline{RFSH} = V_{DD} - 0.2V$	Normal version	-	-	1	mA	
		L version	-	100	200		
I _{DDF1}	Self Refresh Current (Average Current) $\overline{CE} = V_{IH}$ $\overline{RFSH} = V_{IL}$	Normal version	-	-	2	mA	
		L version	-	-	1		
I _{DDF2}	Self Refresh Current (Average Current) $\overline{CE} = V_{DD} - 0.2V$ $\overline{RFSH} = 0.2V$	Normal version	-	-	1	mA	
		L version	-	100	200		
I _{DDF3}	Auto Refresh Current (Average Current) (\overline{RFSH} cycling : $t_{FC} = t_{FC \text{ min}}$)	-	-	2	mA		
I _{DDF4}	CE only Refresh Current (Average Current) (\overline{CE} , Address cycling : $t_{RC} = t_{RC \text{ min}}$)	80ns version	-	50	70	mA	3
		100ns version	-	40	60		
		120ns version	-	35	50		
I _{I(L)}	Input Leakage Current $0V \leq V_{IN} \leq V_{DD}$, All other Inputs not under test = 0V	-10	-	10	μA		
I _{O(L)}	Output Leakage Current Output Disable ($\overline{CE} = V_{IH}$ or $\overline{OE} = V_{IH}$ or $R/W = V_{IL}$), $0V \leq V_{OUT} \leq V_{DD}$	-10	-	10	μA		
V _{OH}	Output High Level $I_{OH} = -5mA$	2.4	-	-	V		
V _{OL}	Output Low Level $I_{OL} = 4.2mA$	-	-	0.4	V		

CAPACITANCE ($V_{DD} = 5V$, $f = 1MHz$, $T_a = 25^\circ C$)

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
C ₁₁	Input Capacitance (A0 ~ A16)	-	5	pF
C ₁₂	Input Capacitance (\overline{CE} , CS, \overline{OE} , R/W, \overline{RFSH})	-	7	pF
C ₁₀	Input/Output Capacitance	-	7	pF

Note) This parameter periodically sampled is not 100% tested.

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ELECTRICAL CHARACTERISTICS AND RECOMMENDED AC OPERATING CONDITIONS

($V_{DD} = 5V \pm 10\%$, $T_a = 0 \sim 70^\circ C$) (NOTES: 5, 6, 7, 8)

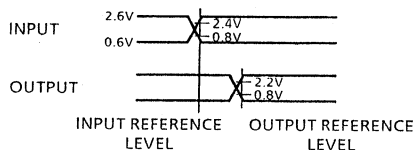
SYMBOL	PARAMETER	-80		-10		-12		UNITS	NOTES
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
t_{RC}	Random Read, Write Cycle Time	130	-	160	-	190	-	ns	
t_{RMW}	Read Modify Write Cycle Time	195	-	235	-	280	-	ns	
t_{CE}	\overline{CE} Pulse Width	80	10,000	100	10,000	120	10,000	ns	
t_p	\overline{CE} Precharge Time	40	-	50	-	60	-	ns	
t_{CEA}	\overline{CE} Access Time	-	80	-	100	-	120	ns	
t_{OEA}	\overline{OE} Access Time	-	35	-	40	-	50	ns	
t_{CLZ}	\overline{CE} to Output in Low-Z	30	-	30	-	30	-	ns	
t_{OLZ}	\overline{OE} to Output in Low-Z	0	-	0	-	0	-	ns	
t_{WLZ}	Output Active from End of Write	0	-	0	-	0	-	ns	
t_{CHZ}	Chip Disable to Output in High-Z	0	25	0	30	0	35	ns	9
t_{OHZ}	\overline{OE} Disable to Output in High-Z	0	25	0	30	0	35	ns	9
t_{WHZ}	Write Enable to Output in High-Z	0	25	0	30	0	35	ns	9
t_{ODS}	\overline{OE} Output Disable Set-Up Time	0	-	0	-	0	-	ns	
t_{ODH}	\overline{OE} Output Disable Hold Time	10	-	10	-	10	-	ns	
t_{RCS}	Read Command Set-Up Time	0	-	0	-	0	-	ns	
t_{RCH}	Read Command Hold Time	0	-	0	-	0	-	ns	
t_{CSS}	Chip Select Set-Up Time	0	-	0	-	0	-	ns	
t_{CSH}	Chip Select Hold Time	20	-	25	-	30	-	ns	
t_{WP}	Write Pulse Width	60	-	70	-	85	-	ns	
t_{WCH}	Write Command Hold Time	60	10,000	70	10,000	85	10,000	ns	
t_{CWL}	Write Command to \overline{CE} Lead Time	60	10,000	70	10,000	85	10,000	ns	
t_{DSW}	Data Set-Up Time from R/W	30	-	35	-	45	-	ns	10
t_{DSC}	Data Set-Up Time from \overline{CE}	30	-	35	-	45	-	ns	10
t_{DHW}	Data Hold Time from R/W	0	-	0	-	0	-	ns	10
t_{DHC}	Data Hold Time from \overline{CE}	0	-	0	-	0	-	ns	10
t_{ASC}	Address Set-Up Time	0	-	0	-	0	-	ns	11
t_{AHC}	Address Hold Time	20	-	25	-	30	-	ns	11
t_{RHC}	RFSH Command Hold Time	15	-	15	-	15	-	ns	
t_{FC}	Auto Refresh Cycle Time	130	-	160	-	190	-	ns	
t_{RFD}	RFSH Delay Time from \overline{CE}	40	-	50	-	60	-	ns	
t_{FAP}	RFSH Pulse Width (Auto Refresh)	30	8,000	30	8,000	30	8,000	ns	12
t_{FP}	RFSH Precharge Time	30	-	30	-	30	-	ns	12
t_{FAS}	RFSH Pulse Width (Self Refresh)	8,000	-	8,000	-	8,000	-	ns	12
t_{FRS}	\overline{CE} Delay Time form RFSH (Self Refresh)	160	-	190	-	225	-	ns	12
t_{REF}	Refresh Period (512 cycle, A0~A8)	-	8	-	8	-	8	ms	
t_T	Transition Time (Rise and Fall)	3	50	3	50	3	50	ns	

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NOTES :

- 1) Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.
- 2) All voltage are referenced to GND.
- 3) I_{DDO} and I_{DDF4} depends on cycle rate.
- 4) I_{DDO} depends on output loading. Specified values are obtained with the output open.
- 5) An initial pause of $100\mu s$ with high \overline{CE} is required after power-up, before proper device operation is achieved.
- 6) AC measurements assume $t_T = 5ns$.
- 7) Timing reference level

Input Level	:	$V_{IH} = 2.6V$
		$V_{IL} = 0.6V$
Input Reference Level	:	$V_{IH} = 2.4V$
		$V_{IL} = 0.8V$
Output Reference Level:		$V_{OH} = 2.2V$
		$V_{OL} = 0.8V$



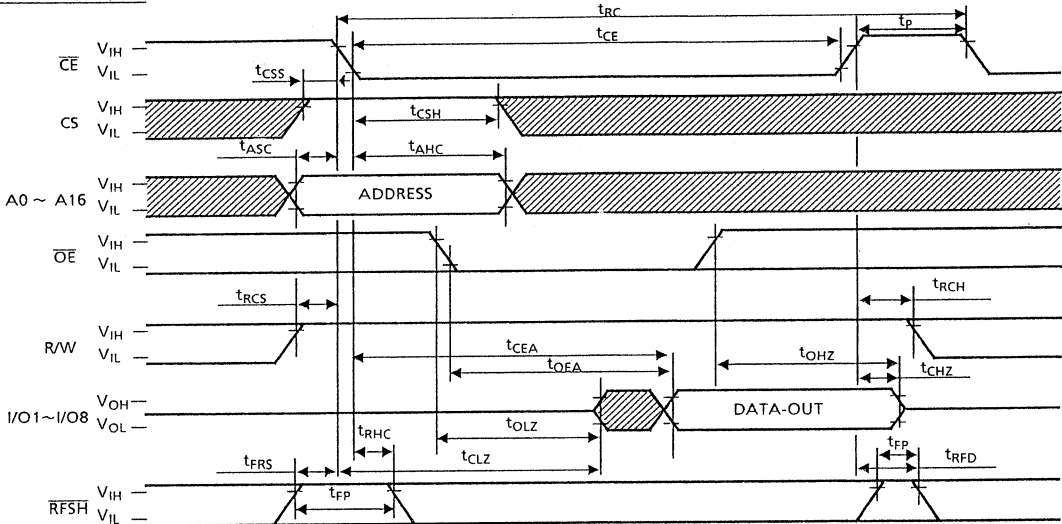
- 8) Measured with a load equivalent to 2 TTL loads and 100pF.
 - 9) t_{CHZ} , t_{OHZ} , t_{WHZ} define the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
 - 10) In write cycles, the input data is latched at the earlier of R/W or \overline{CE} rising edge. Therefore the input data must be valid during set-up time (t_{DSW} or t_{DSC}) and hold time (t_{DHW} or t_{DHC}).
 - 11) All address inputs are latched at the falling edge of \overline{CE} . Therefore the all address inputs must be valid during t_{ASC} and t_{AHC} .
 - 12) Two refresh operation - auto refresh and self refresh are defined by the \overline{RFSH} pulse width under the condition of $\overline{CE} = V_{IH}$.
 - Auto refresh : \overline{RFSH} pulse width $\leq t_{RAP}(\max.)$
 - Self refresh : \overline{RFSH} pulse width $\geq t_{RAS}(\min.)$
- The timing parameter (t_{FRS}) must be kept for device proper operation in the following conditions.
- after self refresh
 - in case of $\overline{RFSH} = "L"$ after power-up

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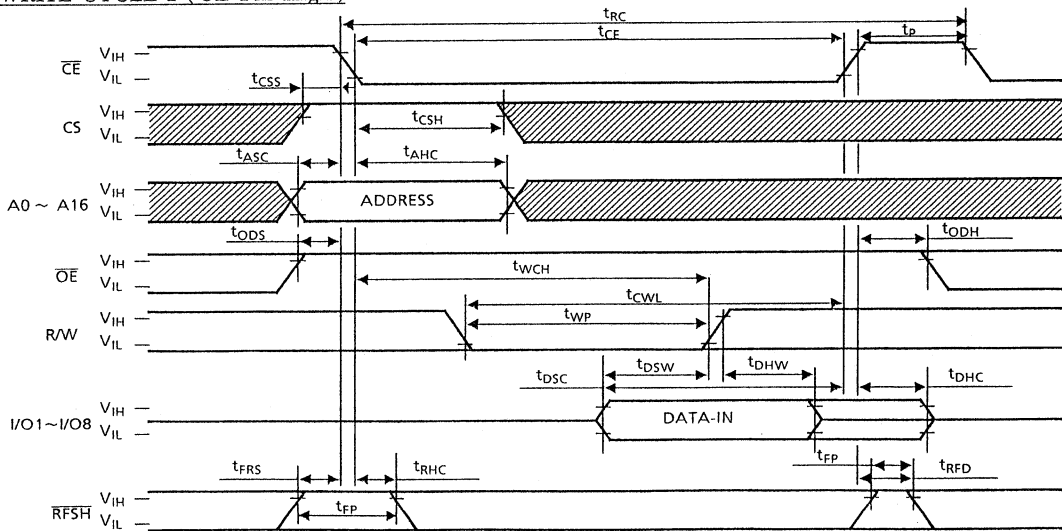
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TIMING WAVEFORMS

READ CYCLE



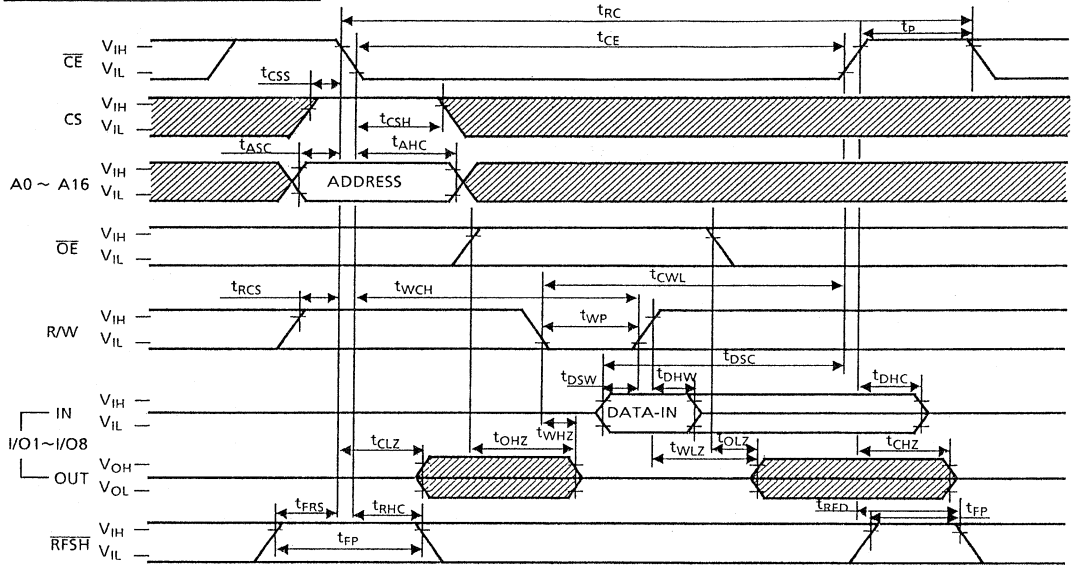
WRITE CYCLE-1 (OE Fix High)



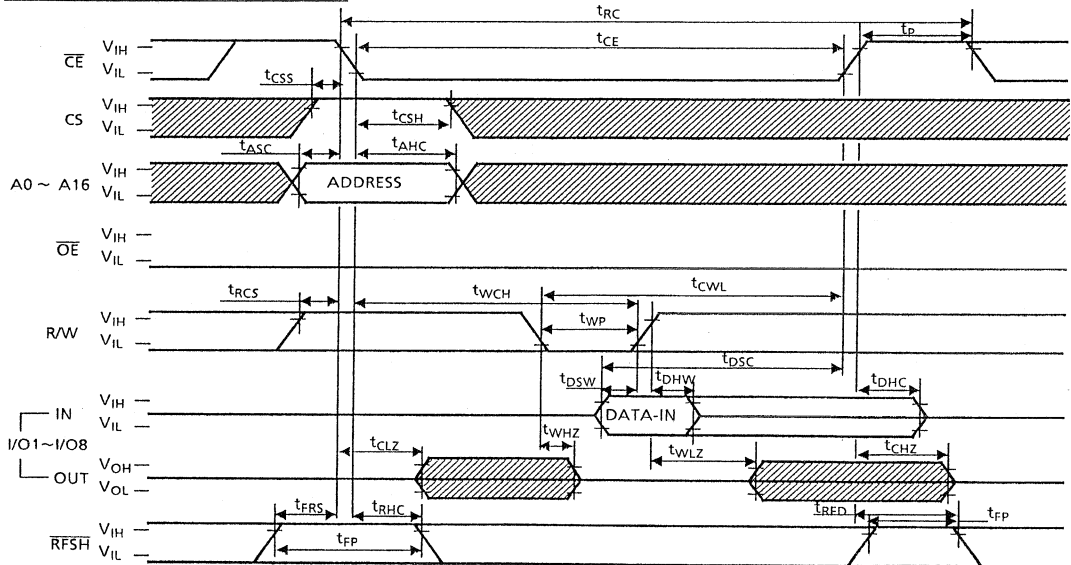
: Don't care

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WRITE CYCLE - 2 (\overline{OE} Clock)



WRITE CYCLE - 3 (\overline{OE} Fix Low)

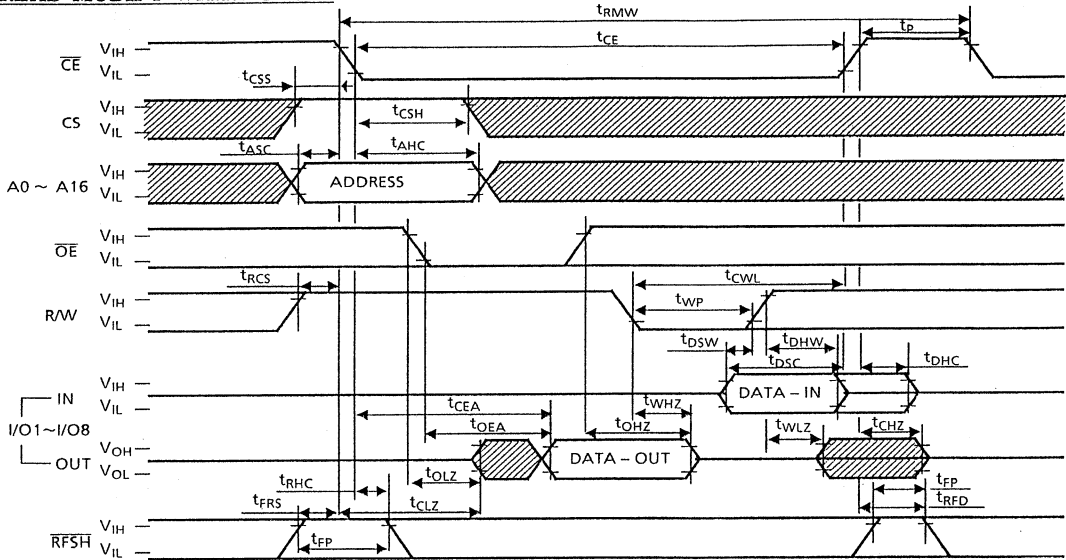


: Don't care

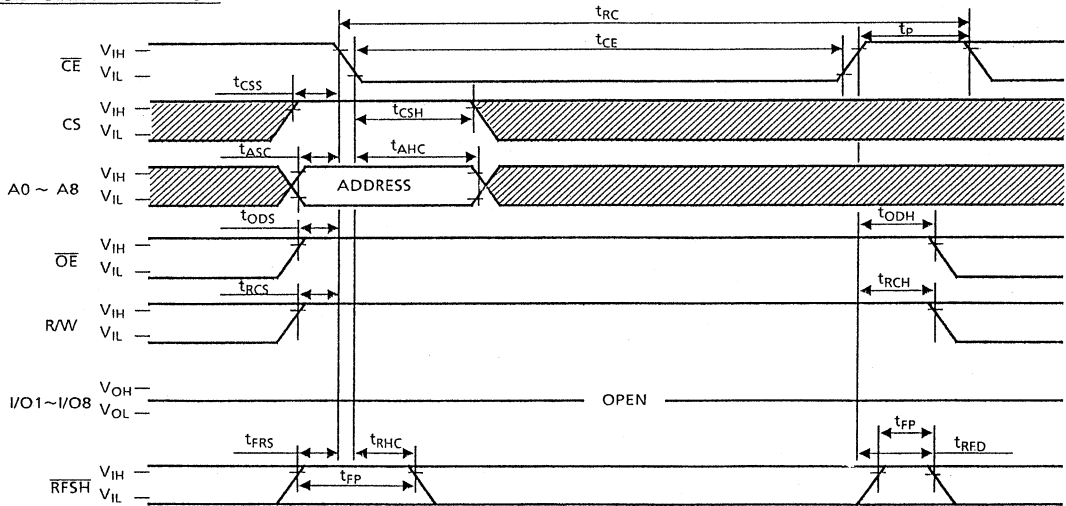
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READ MODIFY WRITE CYCLE



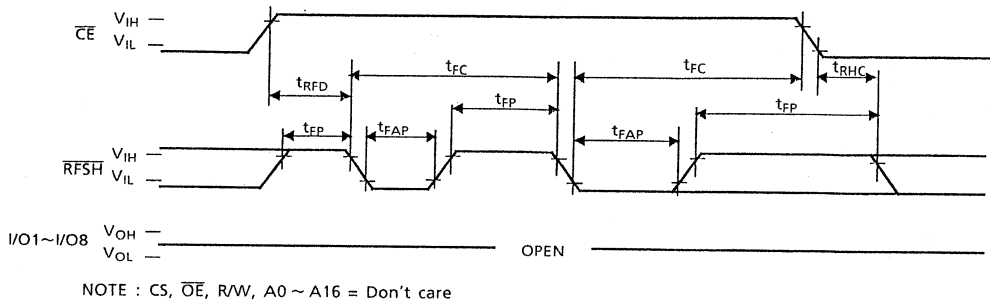
\overline{CE} ONLY REFRESH



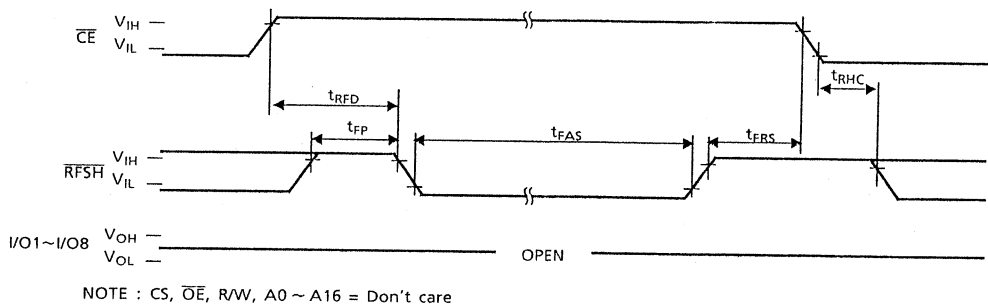
NOTE : A9 ~ A16 = Don't care, : Don't care

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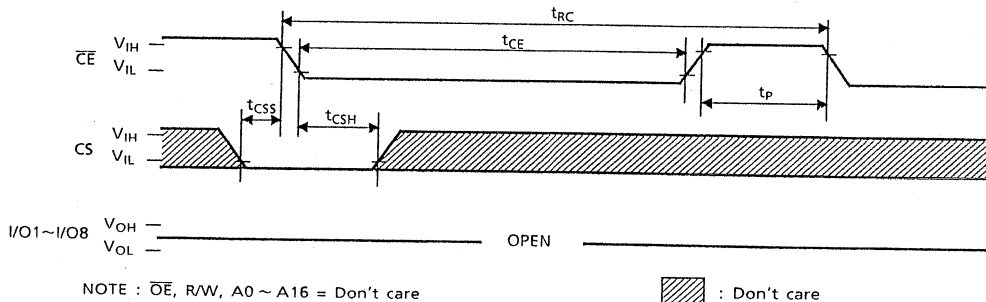
RFSH AUTO REFRESH



SELF REFRESH



CS STANDBY MODE



TOSHIBA

DATA BOOK

MOS MEMORY
(VRAM, SRAM)

1991

INTRODUCTION

We continually venture at the leading edge of technology so that we may develop and offer to you a diverse array of semiconductor memory products which may be used in many commercial and industrial applications. At this time, we offer three data books; "MOS-Memory Dynamic RAM and Module", "MOS-Memory Video RAM and Static RAM" and "MOS-Memory ROM".

Particularly, this data book is "MOS-Memory Video RAM and Static RAM" edition.

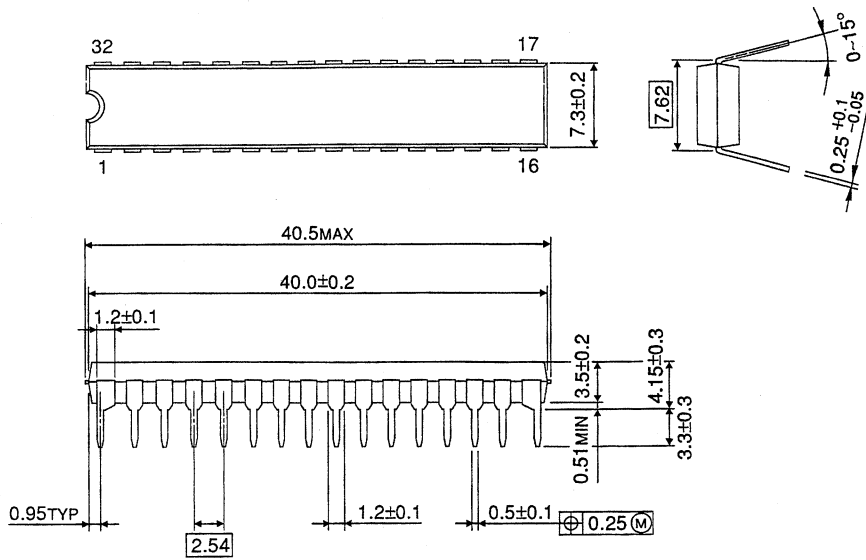
These data books represent our current culminations of electrical characteristics, timing waveforms and package data for our line of semiconductor memory products.

We hope this information will be very useful for you.

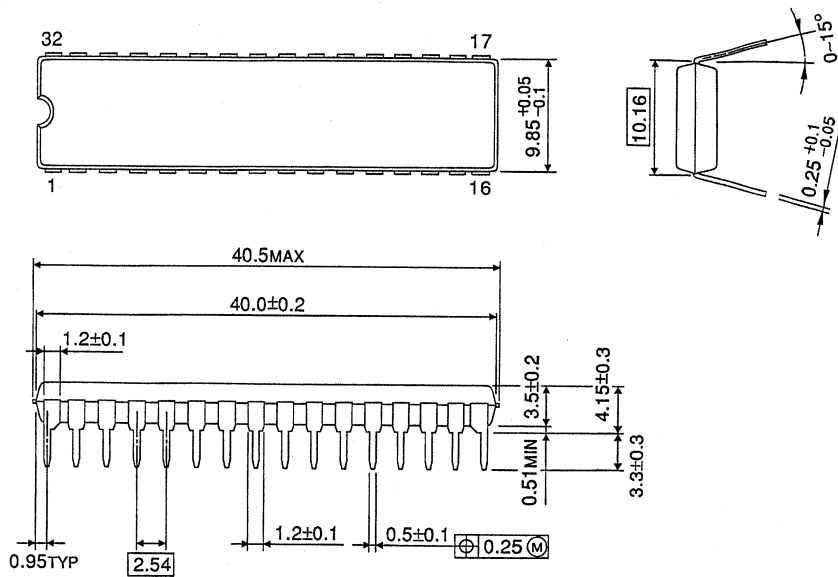
Nov. 1991

TOSHIBA CORPORATION
Semiconductor Group

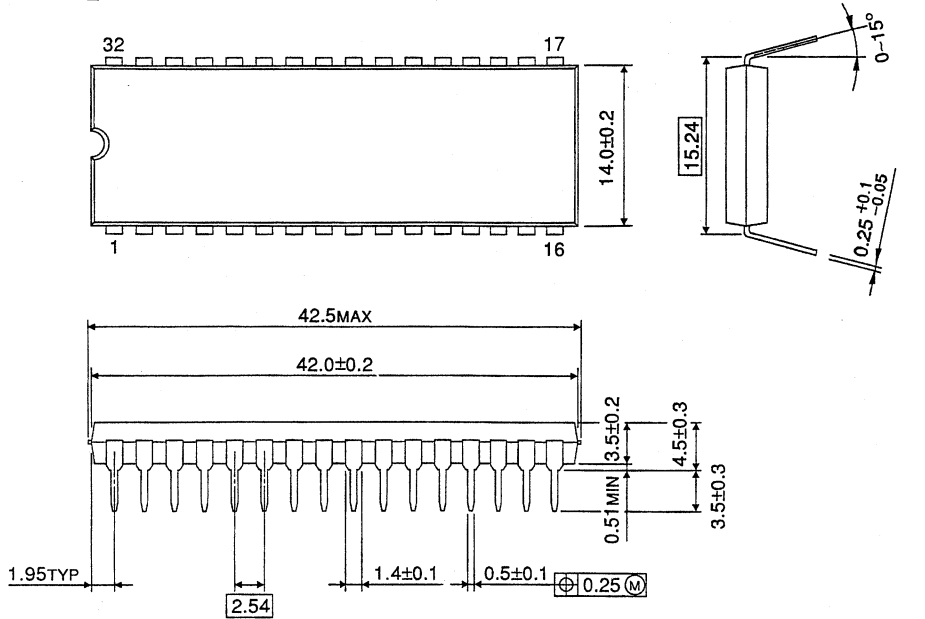
DIP32-P-300



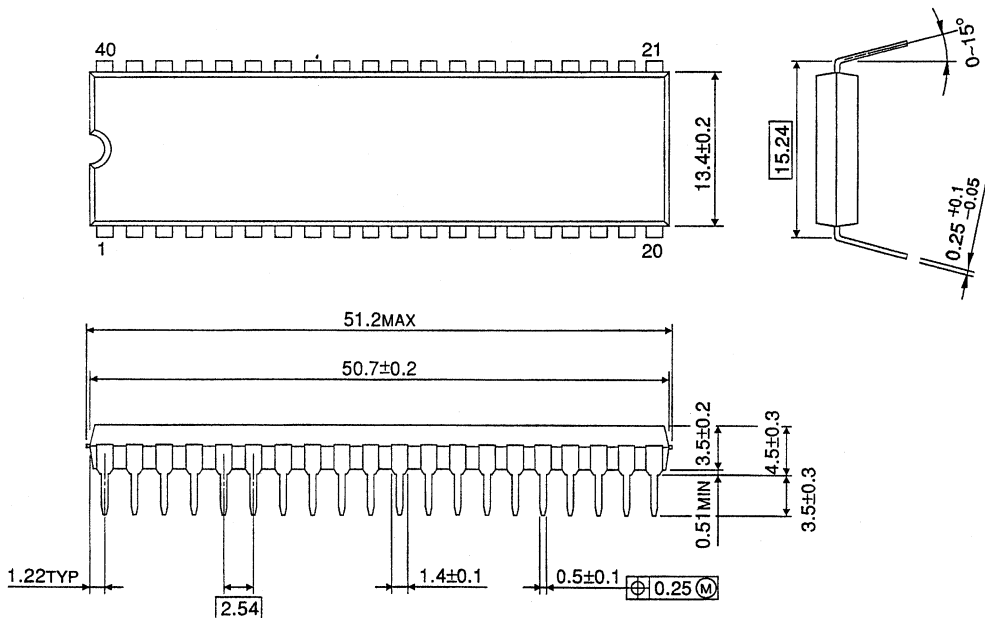
DIP32-P-400



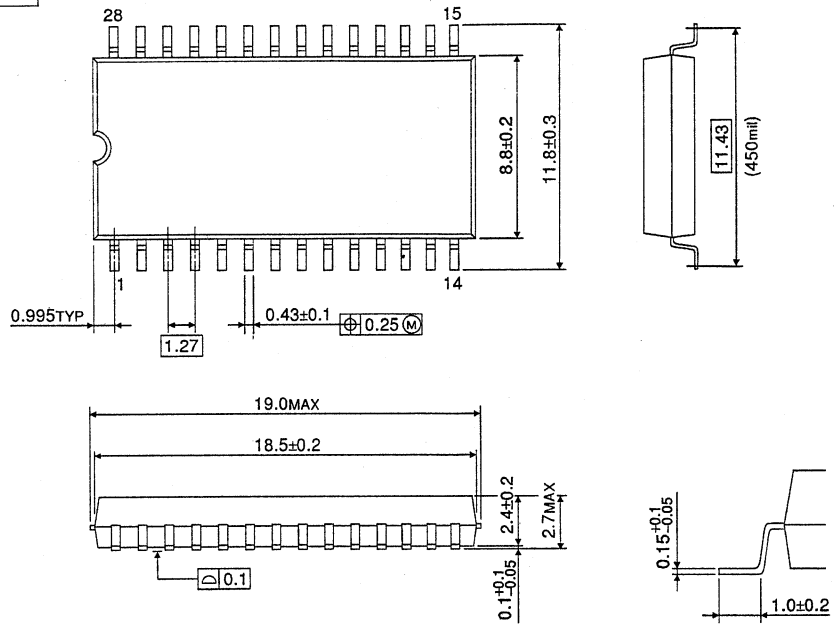
DIP32-P-600



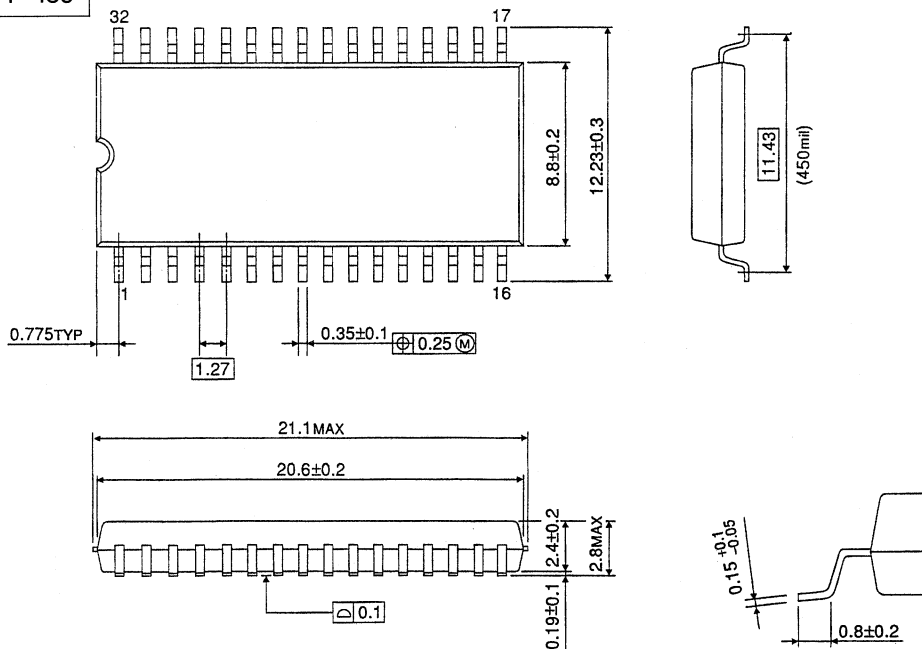
DIP40-P-600

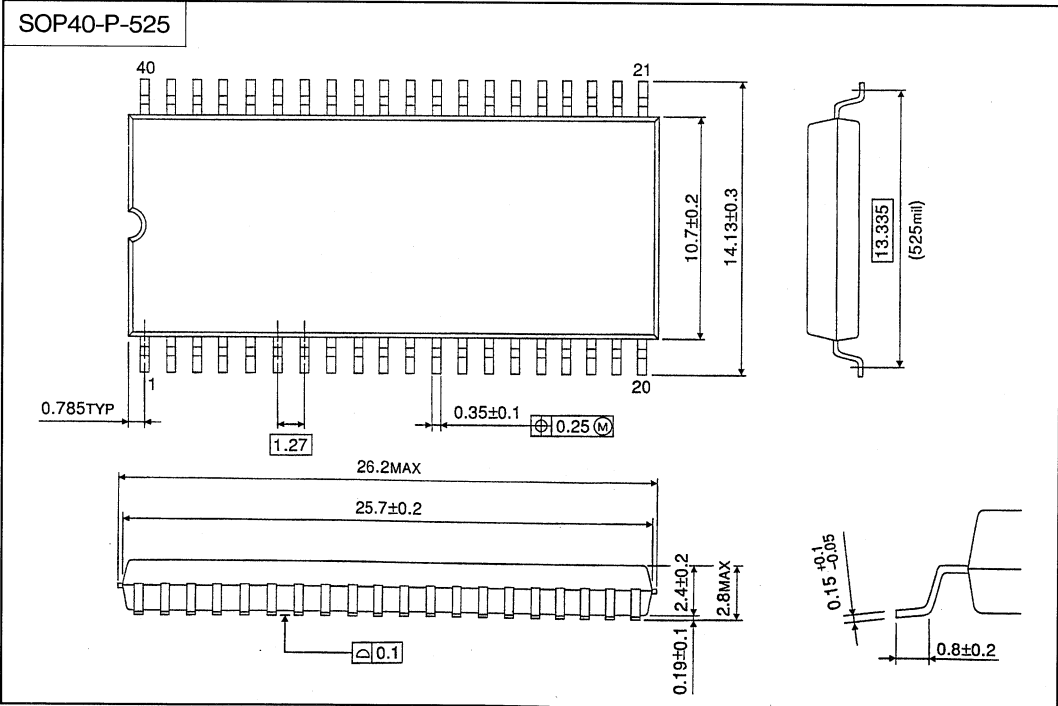
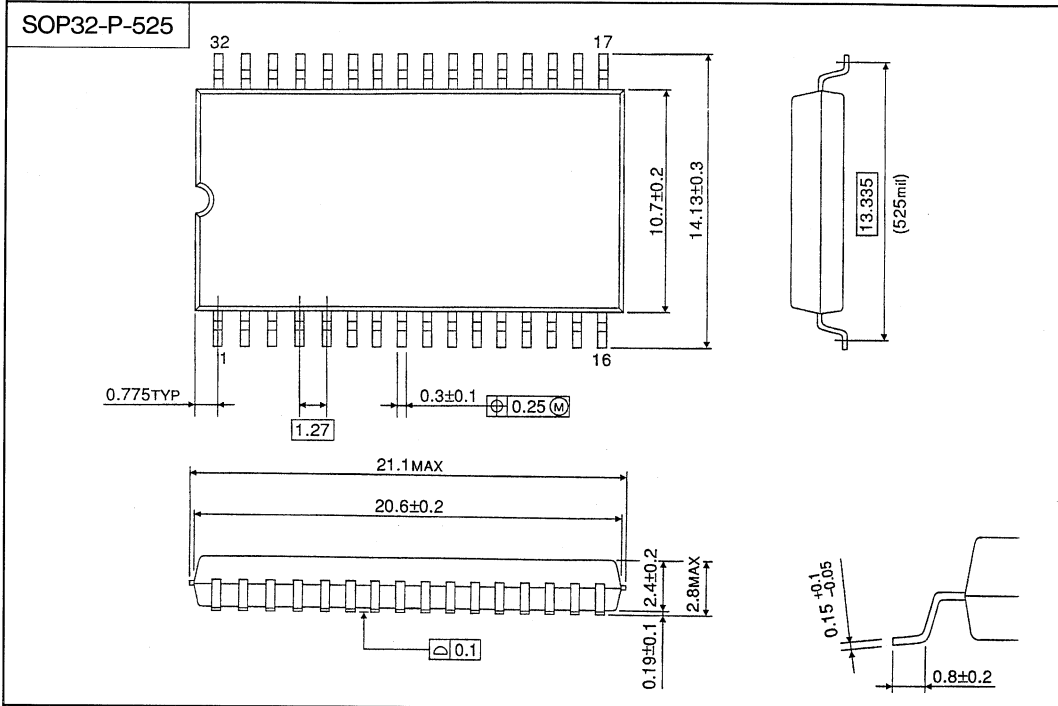


SOP28-P-450



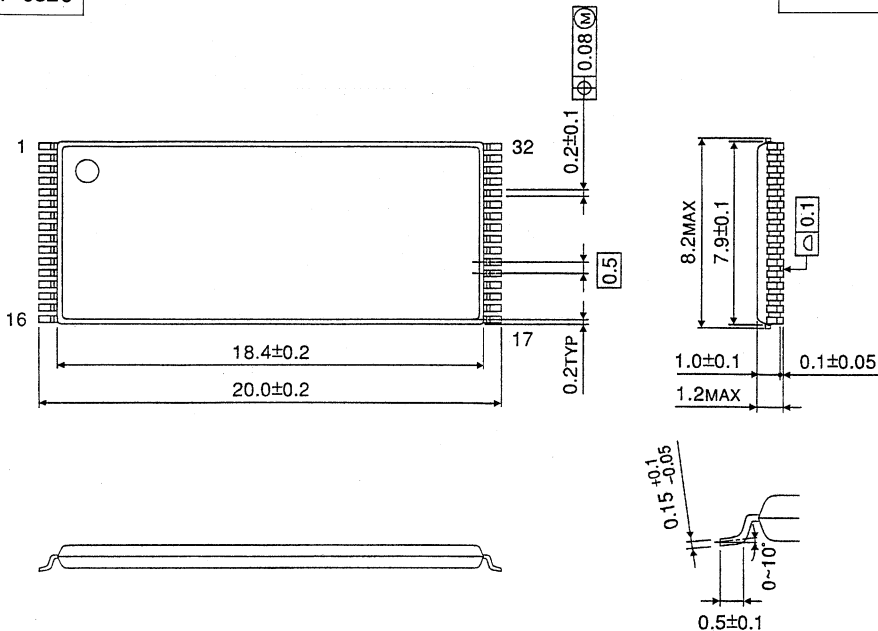
SOP32-P-450





TSOP32-P-0820

TENTATIVE



TSOP32-P-0820A

TENTATIVE

